

Technical Data Sheet

**MPPO (Engineering Plastics)
HSP 8344**

Features High Flow
Applications Semiconductor rill parts

Physical	Test Method	Value
Density	ASTM D792	1.04 g/cm ³
Melt Flow Index (230°C, 21.6kg)	ASTM D1238	25 g/10min
Mold Shrinkage	ASTM D955	0.5 ~ 0.7 %
Water absorption	ASTM D570	- %

Mechanical	Test Method	Value
Tensile Strength	ASTM D638	420 kg/cm ²
Elongation	ASTM D638	15 %
Flexural Strength	ASTM D790	560 kg/cm ²
Flexural Modulus	ASTM D790	17,800 kg/cm ²
Izod Impact Strength(6.4mm)	ASTM D256	6 kg-cm/cm
Rockwell Hardness(R scale)	ASTM D785	103

Thermal	Test Method	Value
Heat Deflection Temperature(18.6kgf/cm ²)	ASTM D648	107 °C (225) (°F)
Vicat Softening Temperature(5kg, 50°C/h)	ASTM D1525	°C (°F)

Flammability	Test Method	Value
Flame Rating - UL (1.6mm)	UL 94	HB

Notes

These are just typical properties, not specifications. Users should confirm results by their own test.